UMENTS Data sheet acquired from Harris Semiconductor SCHS082C - Revised October 2003

# **CMOS 8-Bit Priority** Encoder

High-Voltage Types (20-Volt Rating)

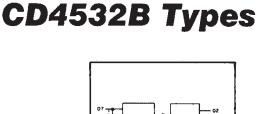
CD4532B consists of combinational logic that encodes the highest priority input (D7-D0) to a 3-bit binary code. The eight inputs, D7 through D0, each have an assigned priority; D7 is the highest priority and D0 is the lowest. The priority encoder is inhibited when the chip-enable input El is low. When E<sub>1</sub> is high, the binary representation of the highest-priority input appears on output lines Q2-Q0, and the group select line GS is high to indicate that priority inputs are present. The enable-out (EO) is high when no priority inputs are present. If any one input is high,  ${\rm E}_{\rm O}$  is low and all cascaded lower-order stages are disabled.

The CD4532B types are supplied in 16-lead hermetic dual-in-line ceramic packages (F3A suffix), 16-lead dual-in-line plastic packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

#### Features:

- Converts from 1 of 8 to binary
- Provides cascading feature to handle any number of inputs
- Group select indicates one or more priority inputs
- Standardized, symmetrical output characteristics
- = 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (full-package-temperature rance):
  - 0.5 V at V<sub>DD</sub> = 5 V

  - 1.5 V at  $V_{DD} = 10 V$ 1.5 V at  $V_{DD} = 15 V$
- = 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"
- Applications:
- Priority encoder
- Binary or BCD encoder (keyboard encoding)
- Floating point arithmetic



SELECT

#### **RECOMMENDED OPERATING CONDITIONS**

For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

FUNCTIONAL DIAGRAM

9205-26360

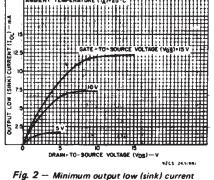
Characteristic	Min.	Max	Units
Supply Voltage Range (for T <sub>A</sub> =	3	18	v
Full Package Temp. Range)			

#### MAXIMUM RATINGS, Absolute-Maximum Values:

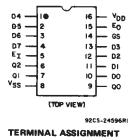
VOLTAGE (VDS)-V Fig. 1 — Typical output low (sink) current

characteristics.

..... N. ..... . .







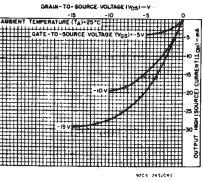
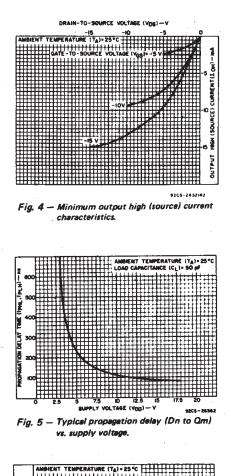


Fig. 3 - Typical output high (source) current characteristics.

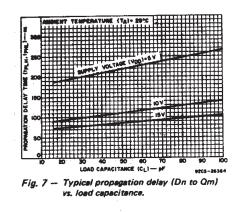
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#### **STATIC ELECTRICAL CHARACTERISTICS**

CHARACTER-	CONE	DITION	IS	LIMITS AT INDICATED TEMPERATURES (°C)							UNITS		
ISTIC	vo	VIN	VDD			·			+25		UNITS		
	(V)	(V)	(V)	55	-40	+85	+125	Min.	Тур.	Max.			
Quiescent Device	-	0,5	5	5	5	150	150	1	0.04	5			
Current,	-	0,10	10	10	10	300	300		0.04	10	μA		
IDD Max.	-	0,15	15	20	20	600	600	-	0.04	20	μΑ		
		0,20	20	100	100	3000	3000	-	0.08	100			
Output Low	0.4	0,5	5	0.64	0.61	0.42	0.36	0.51	1	-			
(Sink) Current	0.5	0,10	10	1.6	1.5	1.1	0.9	1.3	2.6		÷ 4		
IOL Min.	1.5	0,15	15	4.2	4	2.8	2.4	3.4	6.8	-			
Output High	4.6	0,5	5	-0.64	-0.61	-0.42	-0.36	-0.51	-1	-	mA		
(Source)	2.5	0,5	5	-2	-1.8	-1.3	-1.15	-1.6	-3.2	. 7			
Current,	9.5	0,10	10	-1.6	-1.5	-1.1	-0.9	-1.3	-2.6	1 <del></del>	н. 1		
IOH Min.	13.5	0,15	15	-4.2	-4	-2.8	-2.4	-3.4	-6.8	-			
Output Voltage:	_	0,5	5		0	.05			0	0.05			
Low-Level, VOL Max.	-	0,10	10		0	.05		_	0	0.05			
VUL Wax.	-	0,15	15		0	.05		-	0	0.05	v		
Output Voltage:	-	0,5	5		4	.95		4.95	5	-	•		
High-Level,		0,10	10		9	.95		9.95	10	-			
VOH Min.	-	0,15	15		14	1.95		14.95	15	-			
Input Low	0.5, 4.5		5			1		-	-	1.5			
Voltage,	1, 9	·	10		2	.5		-	-	3			
VIL Max.*	1.5,13.5	-	15			3		-	-	4	v		
Input High Voltage, VIH Min.*	0.5, 4.5	-	5			4		3.5	-	—	ľ		
	1, 9		10		7	.5		7	_				
	1.5,13.5	-	15		1	2		11	—	—			
Input Current IIN Max.		0,18	18	±0.1	±0.1	±1	±1	-	±10 <sup>-5</sup>	±0.1	μA		



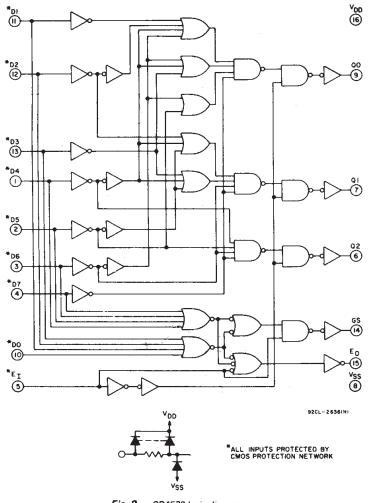
191 H \*One input is tested at a time; other inputs should be at  $V_{DD}$  or  $V_{SS}$ . For testing all inputs at  $V_{IL}$  and  $V_{IH}$  levels, THE (PHIL VE I AV LOAD CAL ACITANCE (CL) --- PF 92CS-26363 Fig. 6 - Typical propagation delay (E; to GS, E; to E) vs. load capacitance.

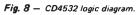


use 20%/80% V<sub>DD</sub>.

# DYNAMIC ELECTRICAL CHARACTERISTICS at TA=25°C; CL=50 pF, Input $t_r, t_f$ = 20 ns, RL=200 K $\Omega$

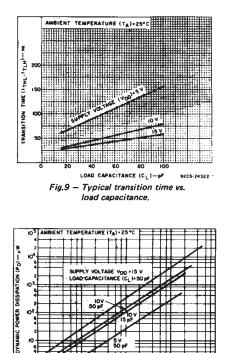
CHARACTERISTIC	TEST CONDITIONS	LIN	UNITS		
	VOLTS	TYP.	MAX.		
Propagation Delay Time tPHL, tPLH	5	110	220		
EI to EO, EI to GS	10	55	110		
	15	45	85		
	5	170	340		
Et to Qm, Dn to GS	10	85	170	ns	
	15	65	125	· · ·	
	5	220	440		
Dn to QM	10	110	220		
	15	85	160	·~ .	
	5	100	200		
Transition Time tTHL, tTLH	10	50	100	ns	
	15	40	80	•	
Input Capacitance CIN	Any Input	5	7.5	pF	



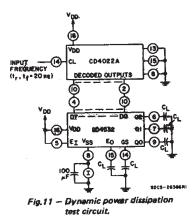


TRU		

Input								C	Dutput				
ε <sub>l</sub>	D7	D6	D5	D4	D3	D2	D1	D0	GS	02	01	Q0	EO
0	X	X	X	X	X	X	X	X	0	0	0	0	0
1	0	0	0	0	0	0	0	0	0	0	0	0	1
1	1	<b>X</b> .	X	X	X	X	X	Х	1	1	1	1	0
1	0	1	X	X	X	X	X	X	1	5 T.J.	1	0	0
1	0	σ	1	X	X	X	X	X	1	1	0	1	0
1	0	0	0	1	X	x	<b>X</b> 1	х	1	1	0	0	0
1	0	0	0	0	1	X	X	Х	1	0	1	1	0
1	0	0	0	0	0	1	X	x	1	0	1	0	0
1	0	0	0	0	0	0	1	х	1	0	0	1	0
1	0	0	0	0	0	0	0	1	1	0	0	0	0
X = Don't Care Logic 1 ≡ High								Log	ic 0 ≡	Low			



3



FREQUENCY (1)

Fig. 10 - Typical dynamic power dissipation vs. frequency.

k Hz

9205-26365

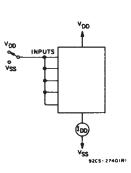


Fig. 12 - Quiescent device current test circuit.

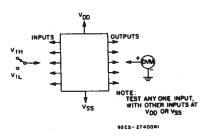


Fig. 13 – Input voltage test circuit.

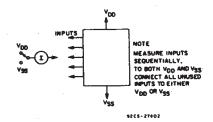
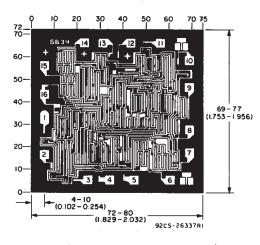


Fig. 14 - Input current test circuit.



Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils  $(10^{-3} \text{ inch})$ .

Dimensions and pad layout for CD4532BH.

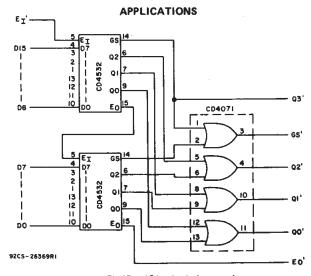
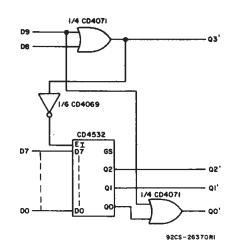


Fig. 15 — 16-level priority encoder.





	Input										Out	tput		
D9	D8	D7	D6	D5	D4	D3	D2	D1	DO	GS	σ3.	Q2'	01'	00'
1	х	X	X	X	X	X	X	х	X	0	1	0	0	1
0	1	X	X.	X	X	X	X	X	X	0	1	0	0	0
0	0	1	X	X	X	X	X	X	X	1-	0	1	1	1
0	0	0	1 1	X	X	X	X	X	X	1	0	1	1	÷ 0.
0	0	0	0	1	X	X I	X	X	X	1	0	1	0	1
0	0	0	0	0	1	X	<b>X</b> -	X	X	1	0	1	0	0
0	0	0	0	0	0	- 1	X	X	X	1	0.	0	1	1
0	0	0	0	0	0	0	1	X	X	1	. 0.	0	1	0
0	0	0	0	0.	0	.0	0	1	X	1	0	0	0	1
0	0	0	0	0	0	0	0	0	1	1	0	0	0	0
X =	Don	't Care Logic 1 ≡ High								L	ogic O I	≣.Lo		

Fig.16 - 0-to-9 keyboard encoder.

J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

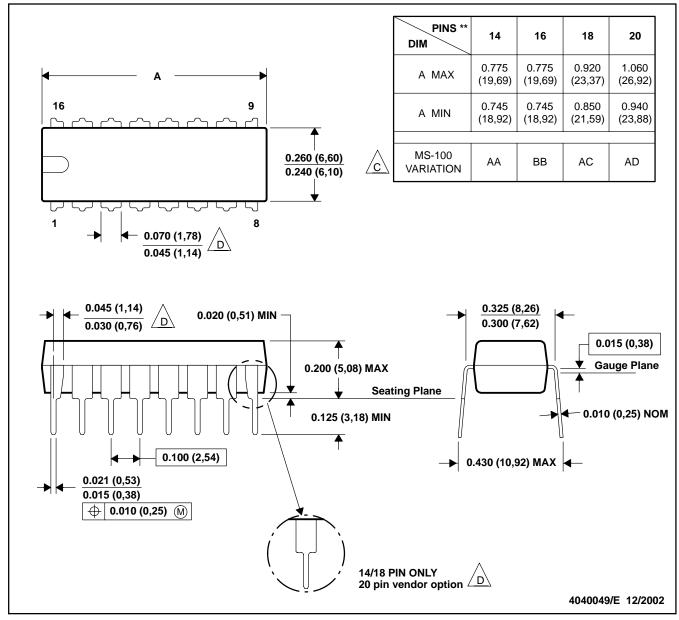
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

MPDI002C - JANUARY 1995 - REVISED DECEMBER 20002

## N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

/д.

- B. This drawing is subject to change without notice.
- /C Falls within JEDEC MS-001, except 18 and 20 pin minimum body Irngth (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

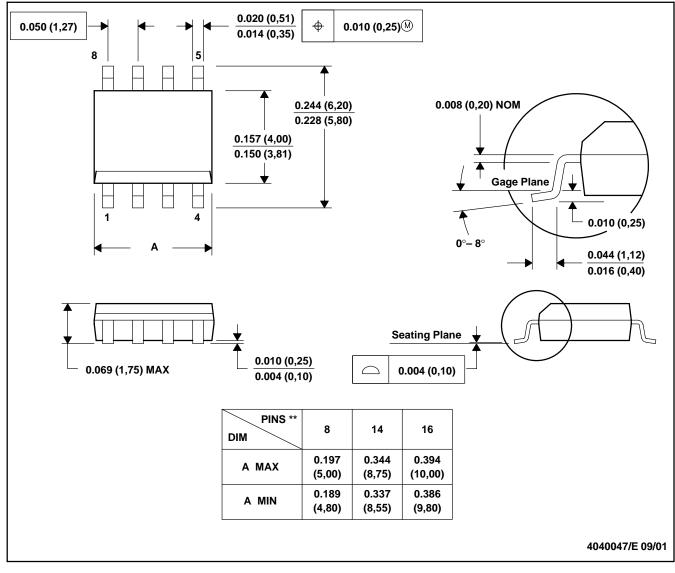


# **MECHANICAL DATA**

MSOI002B - JANUARY 1995 - REVISED SEPTEMBER 2001

#### PLASTIC SMALL-OUTLINE PACKAGE

## D (R-PDSO-G\*\*) 8 PINS SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012



## MECHANICAL DATA

## PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



# **MECHANICAL DATA**

MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

# PW (R-PDSO-G\*\*)

### PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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